

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Charles A. GEALER</td> <td>11/13/2012</td> </tr> <tr> <td>Edward A. ZARBOCK</td> <td>12/03/2012</td> </tr> <tr> <td>Johanna M. SWAN</td> <td>11/12/2012</td> </tr> <tr> <td>Qing MA</td> <td>11/13/2012</td> </tr> <tr> <td>Min TAO</td> <td>12/03/2012</td> </tr> </tbody> </table>		Name	Execution Date	Charles A. GEALER	11/13/2012	Edward A. ZARBOCK	12/03/2012	Johanna M. SWAN	11/12/2012	Qing MA	11/13/2012	Min TAO	12/03/2012
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RECEIVING PARTY DATA													
Name:	Intel Corporation												
Street Address:	2200 Mission College Boulevard												
City:	Santa Clara												
State/Country:	CALIFORNIA												
Postal Code:	95052												
PROPERTY NUMBERS Total: 1													
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13631744</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13631744								
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CORRESPONDENCE DATA													
Fax Number:	5034396073												
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>													
Phone:	(503) 439-8778												
Email:	christi_rouly@bstz.com												
Correspondent Name:	James M. Howard												
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ATTORNEY DOCKET NUMBER:	42P39737												
NAME OF SUBMITTER:	James M. Howard												
Total Attachments: 10													

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For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we, the below-named inventor(s):

Qing MA; Johanna M. SWAN; Min TAO; Charles A. GEALER; Edward T. ZARBOCK

hereby sell, assign, and transfer to

Intel Corporation

a Corporation of Delaware, having a principal place of business at 2200 Mission College Boulevard, Santa Clara, California 95054 United States ("Assignee"), and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States and all foreign countries, in and to any and all inventions or improvements that are disclosed in the application (provisional or non-provisional) for the United States patent which for the non-provisional application may have a declaration executed by the undersigned prior hereto or concurrently herewith and which application (provisional or non-provisional) is entitled

INTERPOSER FOR HERMETIC SEALING OF SENSOR CHIPS AND FOR THEIR INTEGRATION WITH INTEGRATED CIRCUIT CHIPS

said patent application also identified as follows (when known):

[I/we hereby authorize an attorney or agent for said Assignee to insert below the application number and filing date of said patent application when known.]

United States Patent Application Number 13/631,744 filed September 28, 2012,

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agree that said Assignee may apply for and receive a patent or patents for said inventions or improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns, and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all provisional applications, non-provisional applications, utility applications, design applications, divisional applications, continuation applications, continued prosecution applications, continuation-in-part applications, substitute applications, renewal applications, reissue applications, reexaminations, extensions, and all other patent applications on any and all said inventions or improvements; execute all rightful oaths, assignments, powers of attorney, and other papers; communicate to said Assignee, its successors, assigns, and legal representatives all facts known to the undersigned relating to said inventions or improvements and the history thereof; and generally assist said Assignee, its successors, assigns, or legal representatives in securing and maintaining proper patent protection for said inventions or improvements and for vesting title to said inventions or improvements, and all applications for patents and all patents on said inventions or improvements, in said Assignee, its successors, assigns, and legal representatives; and

covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

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1279 Oakmead Parkway
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Telephone: (503) 439-8778

Attorney's Docket No.: 42P39737

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Page 1 of 2

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